
2SK1400, 2SK1400A

Silicon N-Channel MOS FET

HITACHI

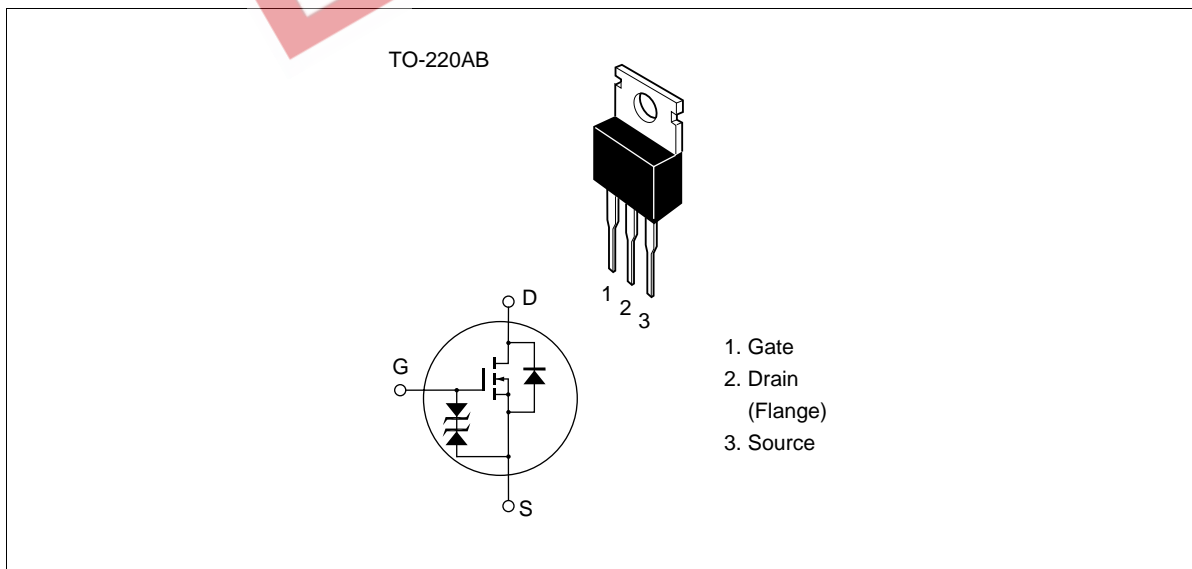
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



2SK1400, 2SK1400A

Absolute Maximum Ratings (Ta = 25°C)

| Item | | Symbol | Ratings | Unit |
|---|----------|---------------------|-------------|------|
| Drain to source voltage | 2SK1400 | V_{DSS} | 300 | V |
| | 2SK1400A | | 350 | |
| Gate to source voltage | | V_{GSS} | ±30 | V |
| Drain current | | I_D | 7 | A |
| Drain peak current | | $I_{D(pulse)}^{*1}$ | 28 | A |
| Body to drain diode reverse drain current | | I_{DR} | 7 | A |
| Channel dissipation | | P_{ch}^{*2} | 50 | W |
| Channel temperature | | T_{ch} | 150 | °C |
| Storage temperature | | T_{stg} | -55 to +150 | °C |

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$

2. Value at $T_c = 25^\circ C$

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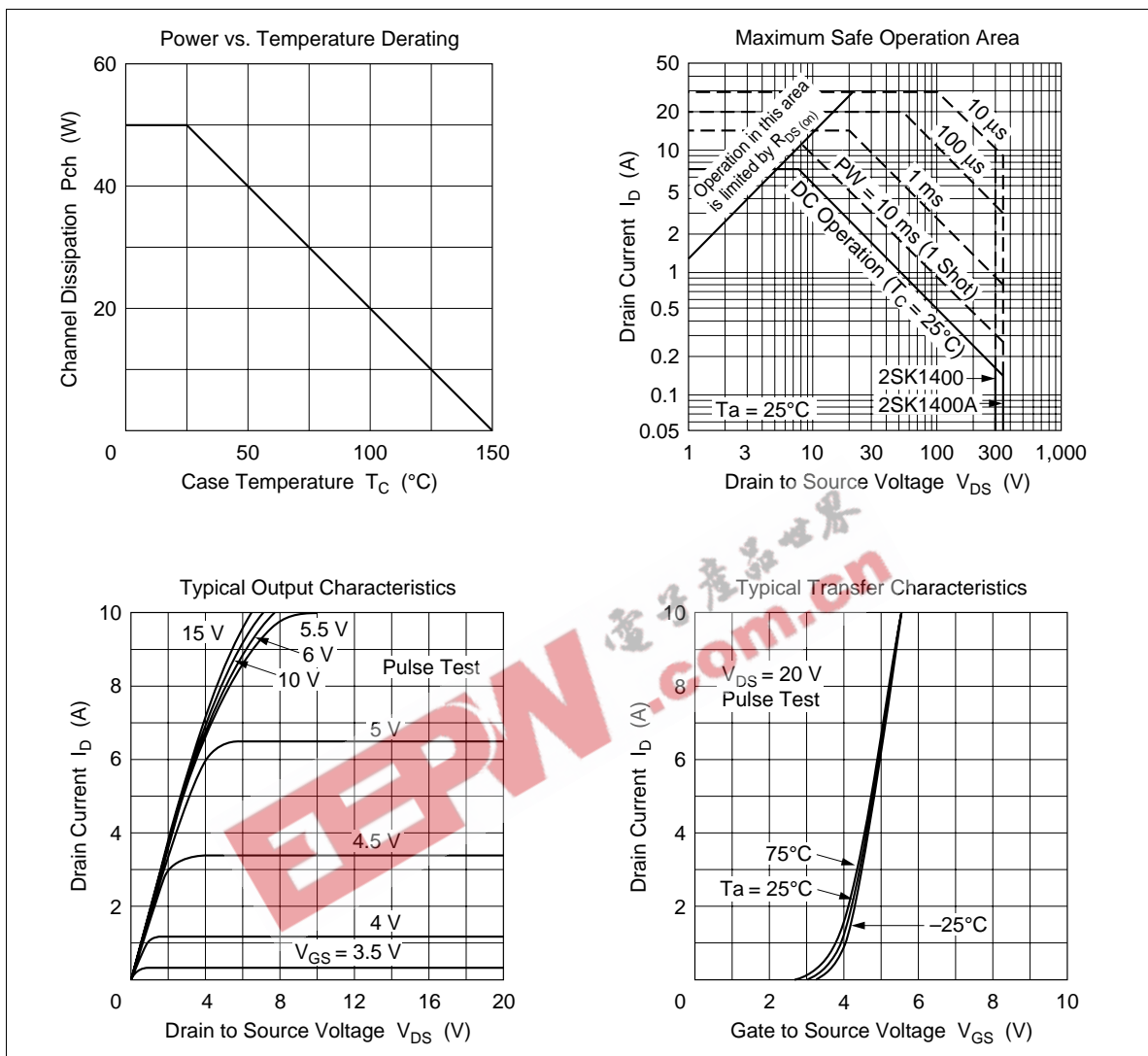
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Electrical Characteristics (T_a = 25°C)

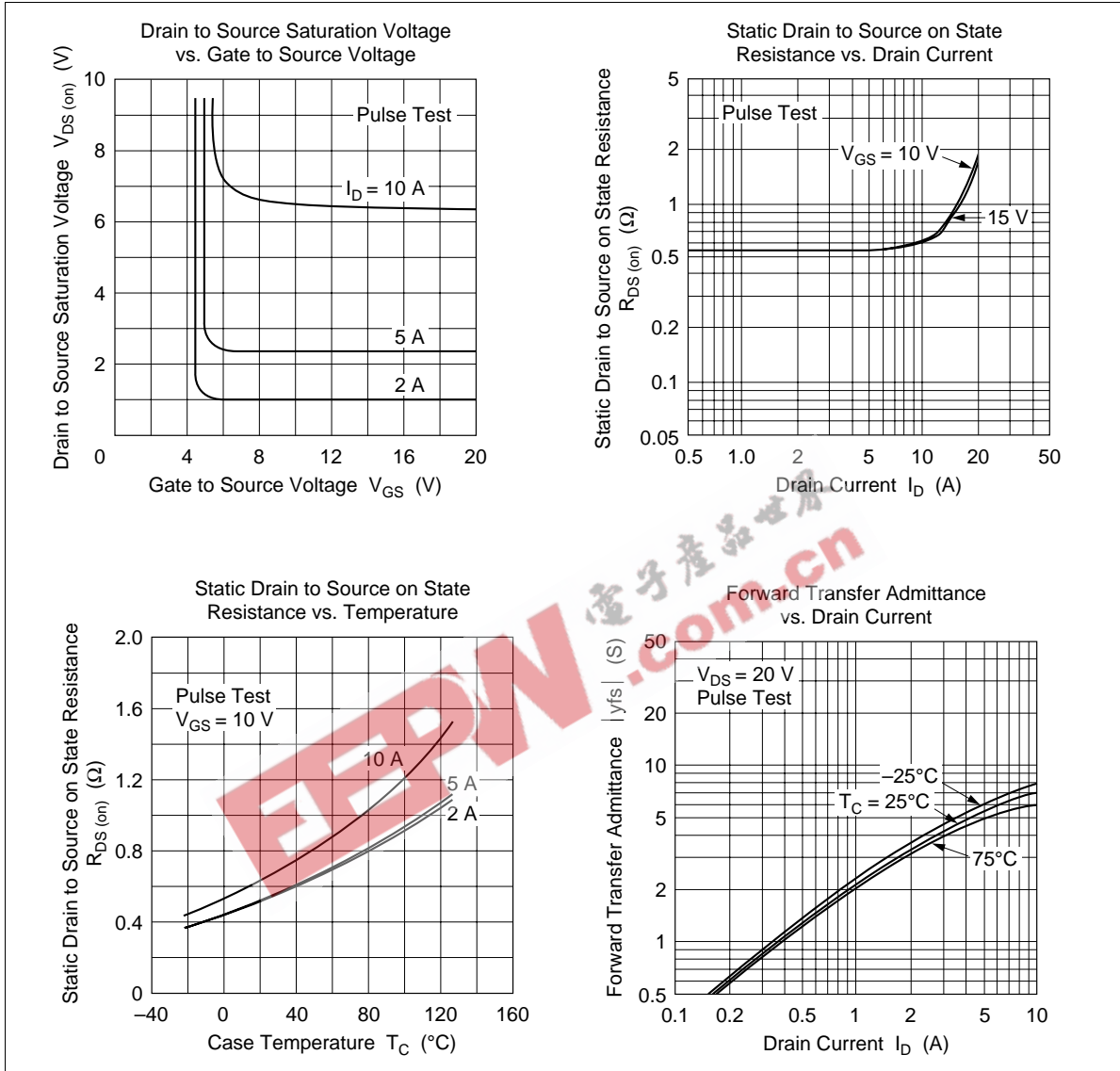
| Item | | Symbol | Min | Typ | Max | Unit | Test conditions |
|---|--------|------------------|-----|------|------|------|---|
| Drain to source breakdown voltage | K1400 | $V_{(BR)DSS}$ | 300 | — | — | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| | K1400A | | 350 | — | — | | |
| Gate to source breakdown voltage | | $V_{(BR)GSS}$ | ±30 | — | — | V | $I_G = \pm 100 \mu\text{A}, V_{DS} = 0$ |
| Gate to source leak current | | I_{GSS} | — | — | ±10 | μA | $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | K1400 | I_{DSS} | — | — | 250 | μA | $V_{DS} = 240 \text{ V}, V_{GS} = 0$ |
| | K1400A | | | | | | $V_{DS} = 280 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | | $V_{GS(off)}$ | 2.0 | — | 3.0 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on state resistance | K1400 | $R_{DS(on)}$ | — | 0.50 | 0.70 | Ω | $I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$ |
| | K1400A | | | 0.60 | 0.80 | | |
| Forward transfer admittance | | y _{fs} | 3.0 | 5.0 | — | S | $I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$ |
| Input capacitance | | C _{iss} | — | 635 | — | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$ |
| Output capacitance | | C _{oss} | — | 230 | — | pF | $f = 1 \text{ MHz}$ |
| Reverse transfer capacitance | | C _{rss} | — | 40 | — | pF | |
| Turn-on delay time | | $t_{d(on)}$ | — | 10 | — | ns | $I_D = 4 \text{ A}, V_{GS} = 10 \text{ V},$ |
| Rise time | | t_r | — | 50 | — | ns | $R_L = 7.5 \Omega$ |
| Turn-off delay time | | $t_{d(off)}$ | — | 60 | — | ns | |
| Fall time | | t_f | — | 40 | — | ns | |
| Body to drain diode forward voltage | | V_{DF} | — | 1.0 | — | V | $I_F = 7 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery time | | t_{rr} | — | 240 | — | ns | $I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ |

Note: 1. Pulse test

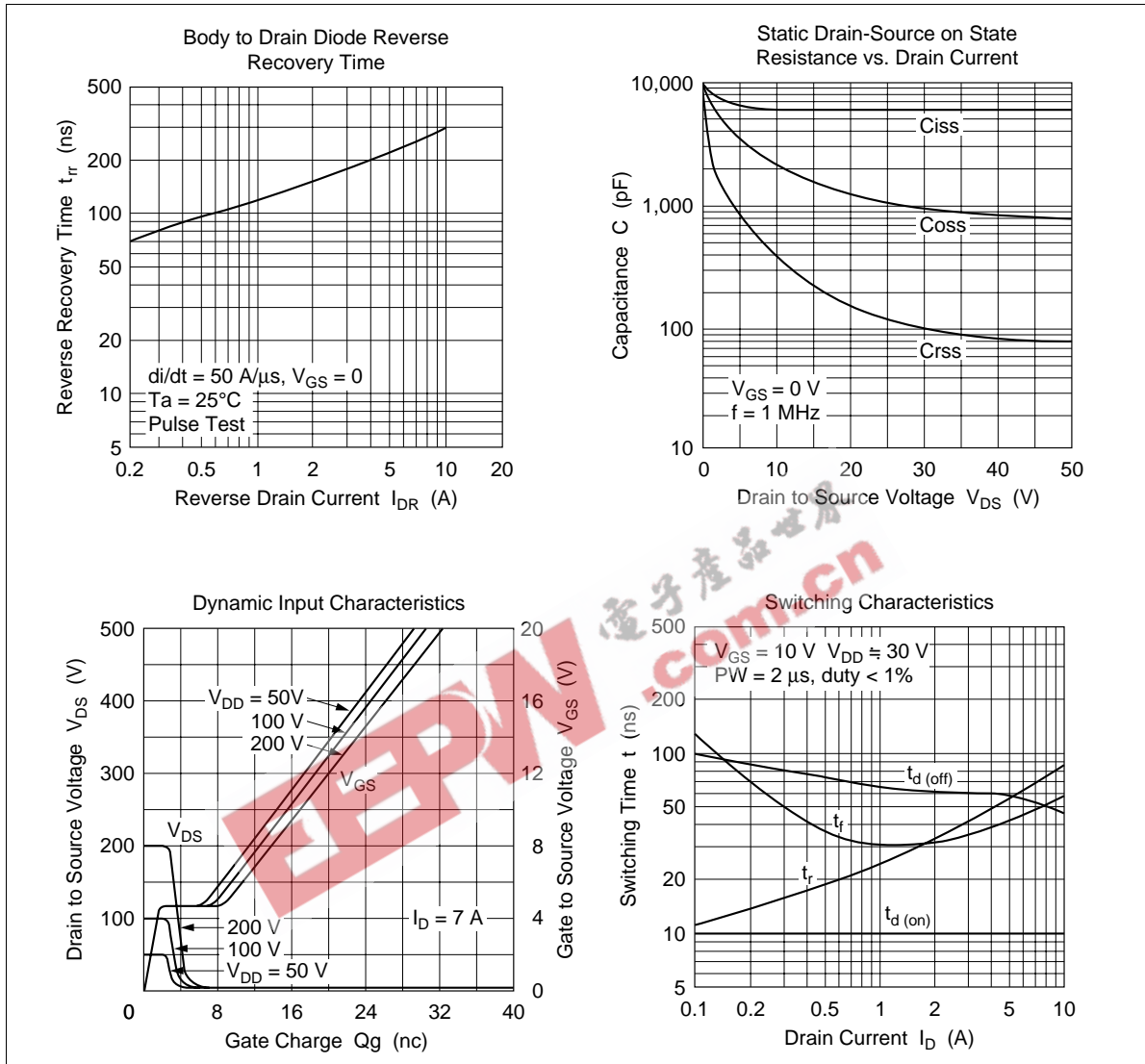
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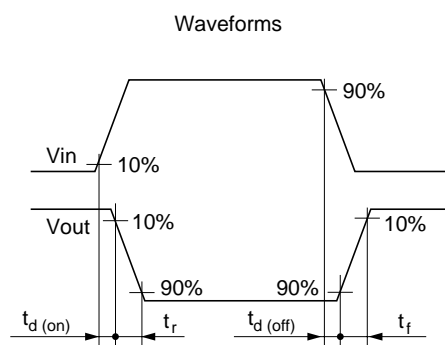
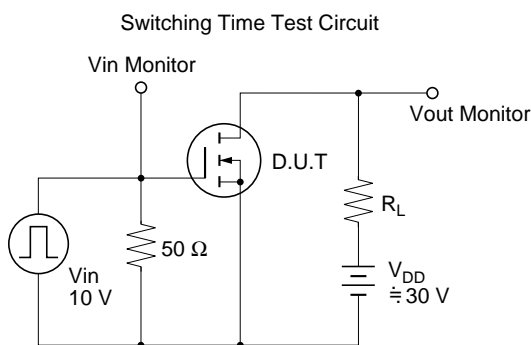
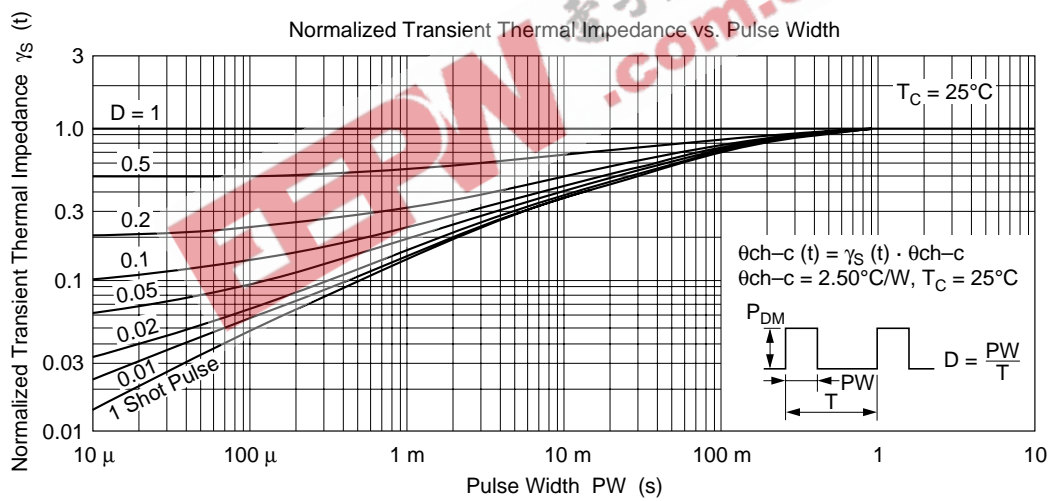
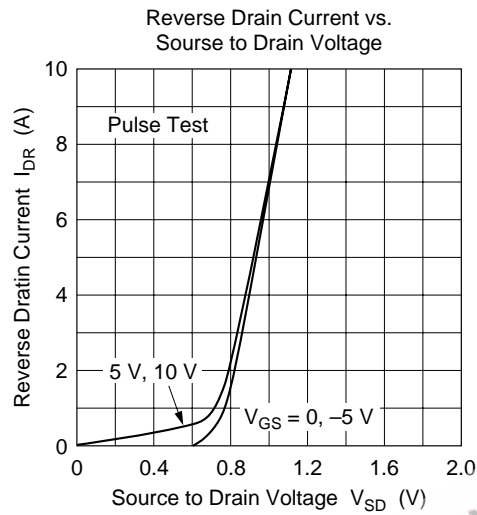


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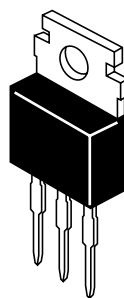
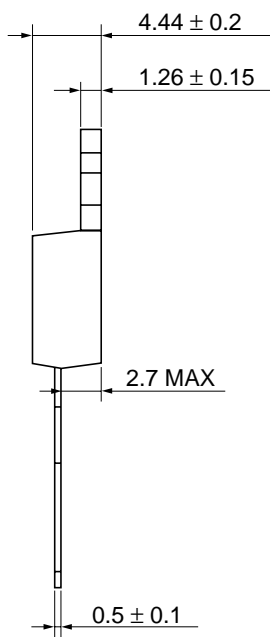
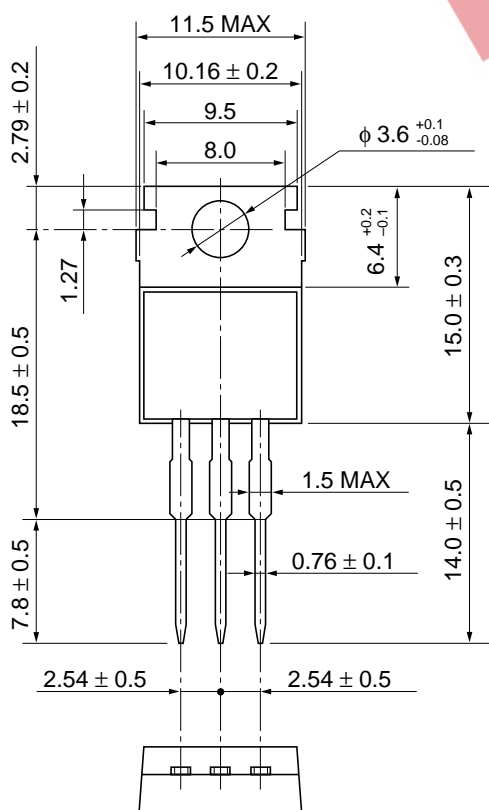


2SK1400, 2SK1400A





Unit: mm



| | |
|--------------------------|----------|
| Hitachi Code | TO-220AB |
| JEDEC | Conforms |
| EIAJ | Conforms |
| Weight (reference value) | 1.8 g |

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